

TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

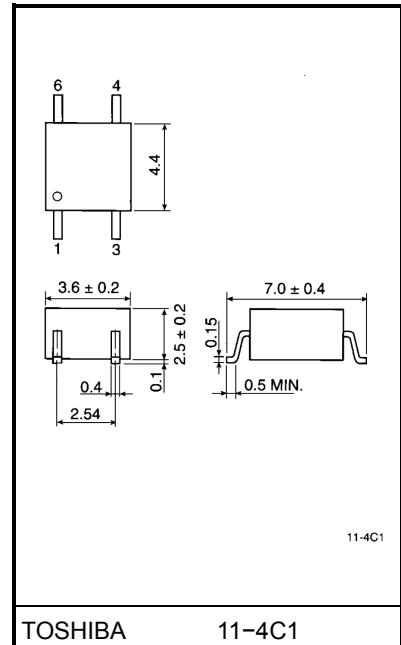
TLP126

Programmable Controllers
AC / DC-Input Module
Telecommunication

Unit in mm

The TOSHIBA mini flat coupler TLP126 is a small outline coupler, suitable for surface mount assembly.
TLP126 consists of a photo transistor, optically coupled to a gallium arsenide infrared emitting diode connected inverse parallel, and provides high CTR at low AC input current.

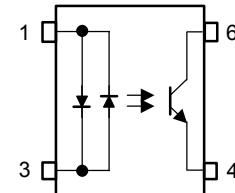
- Collector-emitter voltage: 80 V (min.)
- Current transfer ratio: 100% (min.)
- Isolation voltage: 3750Vrms (min.)
- UL recognized: UL1577, file No. E67349



11-4C1

TOSHIBA 11-4C1

Weight: 0.09 g

Pin Configurations (top view)

1 : Anode, Cathode
3 : Cathode, Anode
4 : Emitter
6 : Collector

Maximum Ratings (Ta = 25°C)

| Characteristic | | Symbol | Rating | Unit |
|--|---|----------------------|---------|---------|
| LED | Forward current | I _{F(RMS)} | 50 | mA |
| | Forward current derating (Ta ≥ 53°C) Δ | ΔI _F / °C | -0.7 | mA / °C |
| | Peak forward current(100μs pulse,100pps) | I _{FP} | 1 | A |
| | Junction temperature | T _j | 125 | °C |
| Detector | Collector-emitter voltage | V _{CEO} | 80 | V |
| | Emitter-collector voltage | V _{ECO} | 7 | V |
| | Collector current | I _C | 50 | mA |
| | Peak collector current(10ms pulse,100pps) | I _{CP} | 100 | mA |
| | Power dissipation | P _C | 150 | mW |
| | Power dissipation derating (Ta ≥ 25°C) | ΔP _C / °C | -1.5 | mW / °C |
| | Junction temperature | T _j | 125 | °C |
| Storage temperature range | | T _{stg} | -55~125 | °C |
| Operating temperature range | | T _{opr} | -55~100 | °C |
| Lead soldering temperature(10 sec.) | | T _{sold} | 260 | °C |
| Total package power dissipation | | P _T | 200 | mW |
| Total package power dissipation derating (Ta ≥ 25°C) | | ΔP _T / °C | -2.0 | mW / °C |
| Isolation voltage (AC, 1min., RH ≤ 60%) (Note 1) | | BVS | 3750 | Vrms |

(Note 1) Device considered a two terminal device: Pins 1, and 3 shorted together and 4 and 6 shorted together.

Recommended Operating Conditions

| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|-----------------------|---------------------|------|------|------|------|
| Supply voltage | V _{CC} | — | 5 | 48 | V |
| Forward current | I _{F(RMS)} | — | 1.6 | 20 | mA |
| Collector current | I _C | — | 1 | 10 | mA |
| Operating temperature | T _{opr} | -25 | — | 75 | °C |

Individual Electrical Characteristics (Ta = 25°C)

| Characteristic | | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|----------------|-------------------------------------|-----------------------|-----------------------------------|------|------|------|------|
| LED | Forward voltage | V _F | I _F = ±10 mA | 1.0 | 1.15 | 1.3 | V |
| | Capacitance | C _T | V = 0, f = 1 MHz | — | 60 | — | pF |
| Detector | Collector-emitter breakdown voltage | V _{(BR) CEO} | I _C = 0.5 mA | 80 | — | — | V |
| | Emitter-collector breakdown voltage | V _{(BR) ECO} | I _E = 0.1 mA | 7 | — | — | V |
| | Collector dark current | I _{CEO} | V _{CE} = 48 V | — | 10 | 100 | nA |
| | | | V _{CE} = 48 V, Ta = 85°C | — | 2 | 50 | μA |
| | Capacitance collector to emitter | C _{CE} | V = 0, f = 1 MHz | — | 12 | — | pF |

Coupled Electrical Characteristics (Ta = 25°C)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------|---------------------------------------|--|------|------|------|------|
| Current transfer ratio | I _C / I _F | I _F = ±1 mA, V _{CE} = 0.5 V | 100 | — | 1200 | % |
| Low input CTR | I _C / I _F (low) | I _F = ±0.5 mA, V _{CE} = 1.5 V | 50 | — | — | % |
| Collector-emitter saturation voltage | V _{CE} (sat) | I _C = 0.5 mA, I _F = ±1 mA | — | — | 0.4 | V |
| | | I _C = 1 mA, I _F = ±1 mA | — | 0.2 | — | |
| Off-state collector current | I _{C(off)} | V _F = ±0.7V, V _{CE} = 48 V | — | 1 | 10 | μA |
| CTR symmetry | I _C (ratio) | I _C (I _F = -1mA) / I _C (I _F = 1mA) | 0.3 | — | 3 | — |

Coupled Electrical Characteristics (Ta = -25~75°C)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|------------------------|---------------------------------------|--|------|------|------|------|
| Current transfer ratio | I _C / I _F | I _F = 1 mA, V _{CE} = 0.5 V | 50 | — | — | % |
| Low input CTR | I _C / I _F (low) | I _F = 0.5 mA, V _{CE} = 1.5 V | — | 50 | — | % |

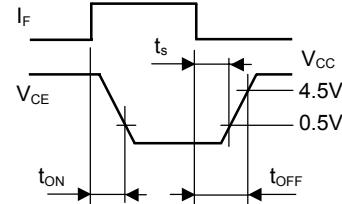
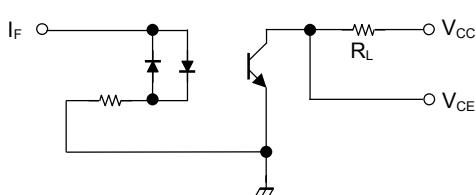
Isolation characteristics ($T_a = 25^\circ C$)

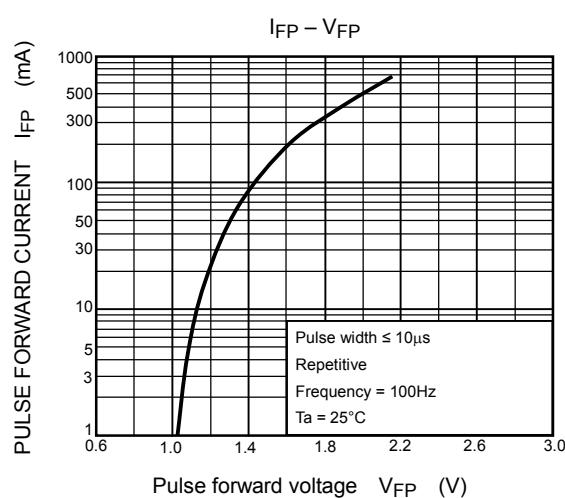
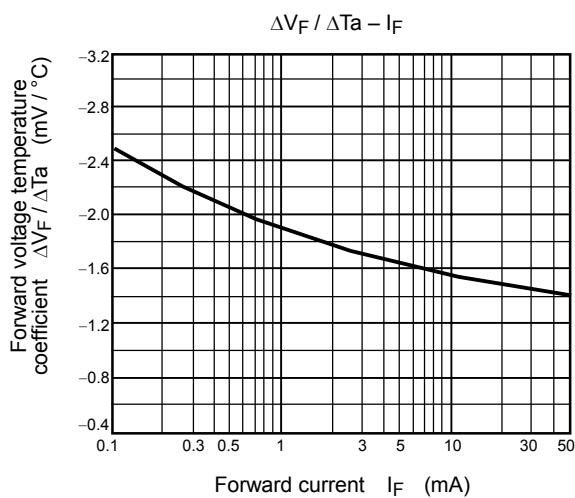
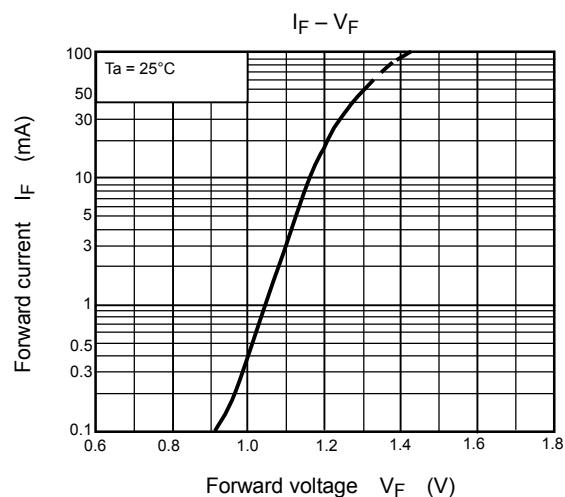
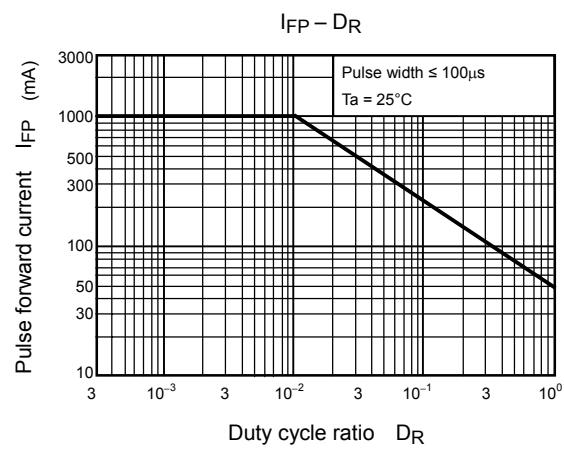
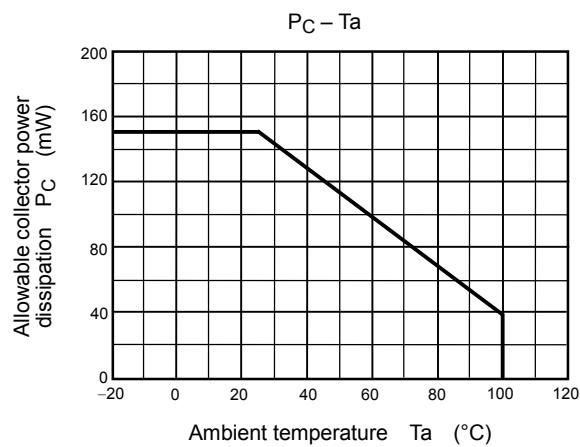
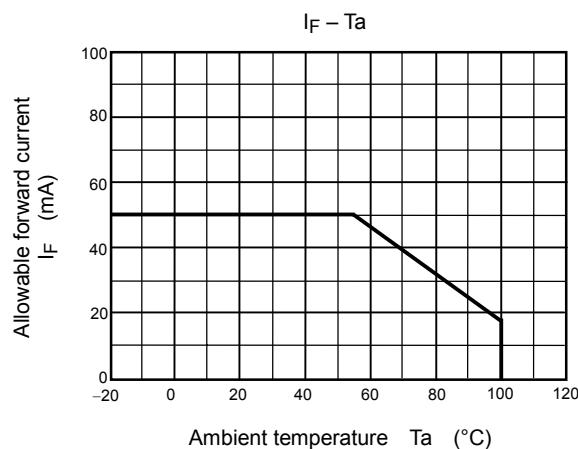
| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|-----------------------------|--------|------------------------------|--------------------|-----------|------|-------------------------|
| Capacitance input to output | C_S | $V_S = 0, f = 1 \text{ MHz}$ | — | 0.8 | — | pF |
| Isolation resistance | R_S | $V_S = 500 \text{ V}$ | 5×10^{10} | 10^{14} | — | Ω |
| Isolation voltage | BVS | AC, 1 minute | 3750 | — | — | V_{rms} |
| | | AC, 1 second, in oil | — | 10000 | — | |
| | | DC, 1 minute, in oil | — | 10000 | — | Vdc |

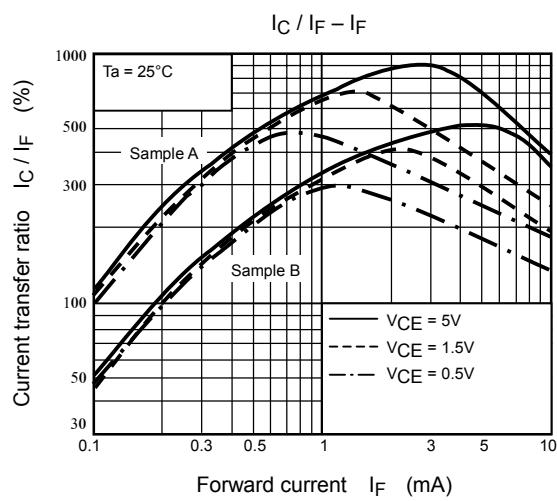
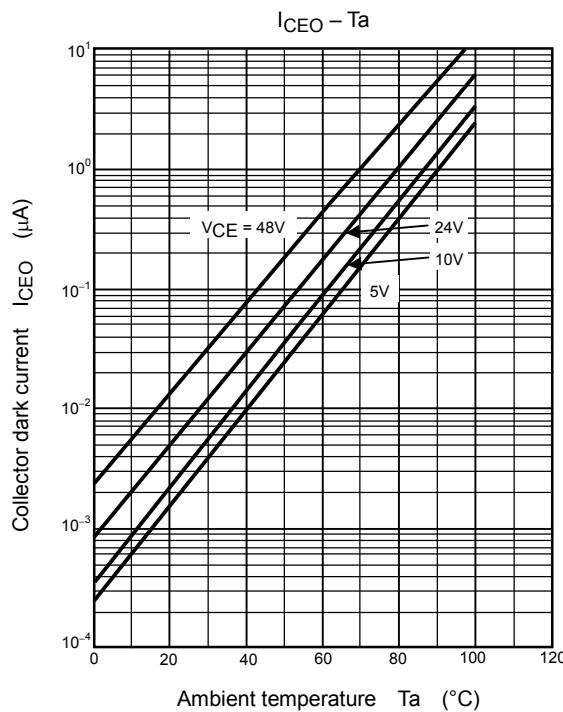
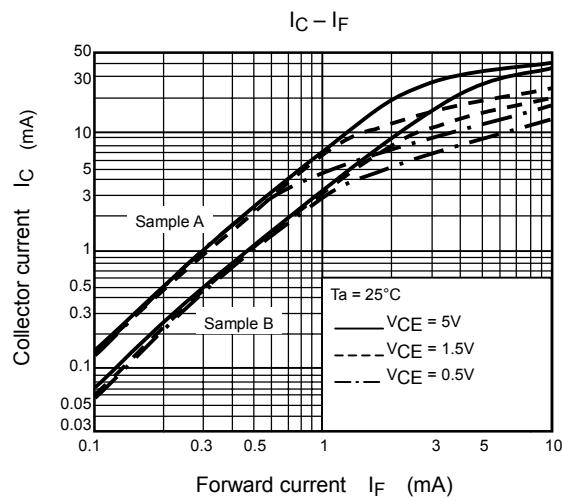
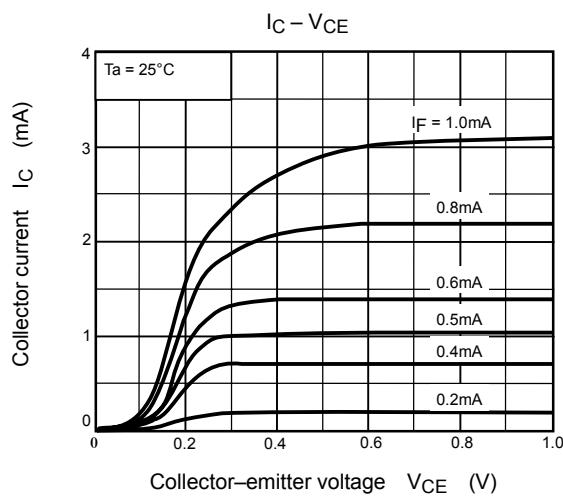
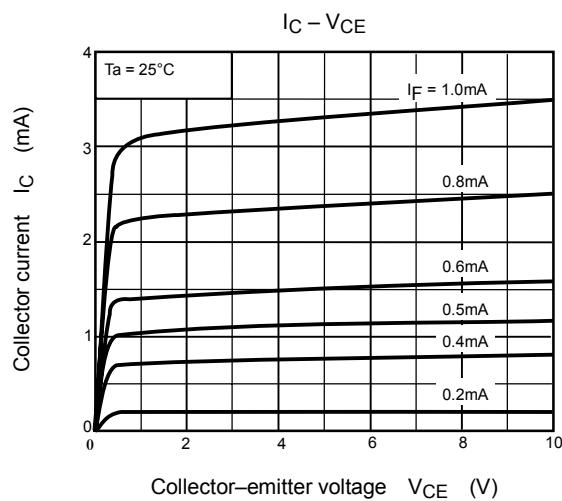
Switching Characteristics ($T_a = 25^\circ C$)

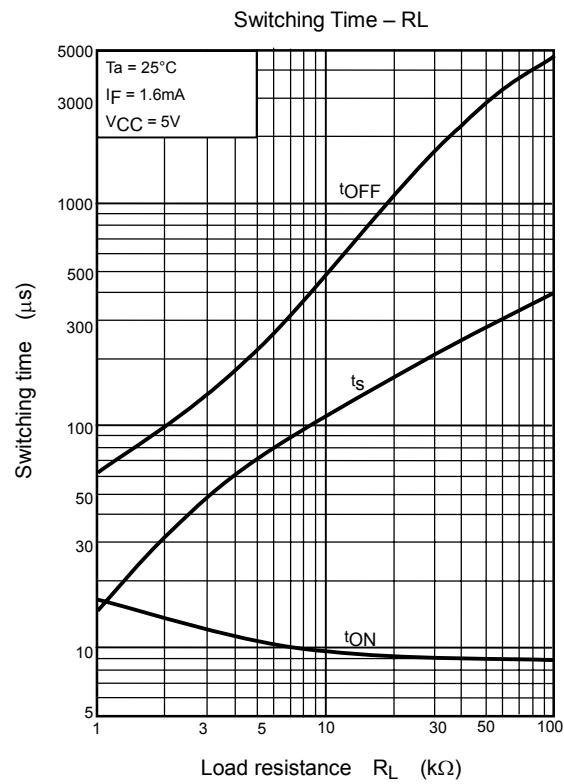
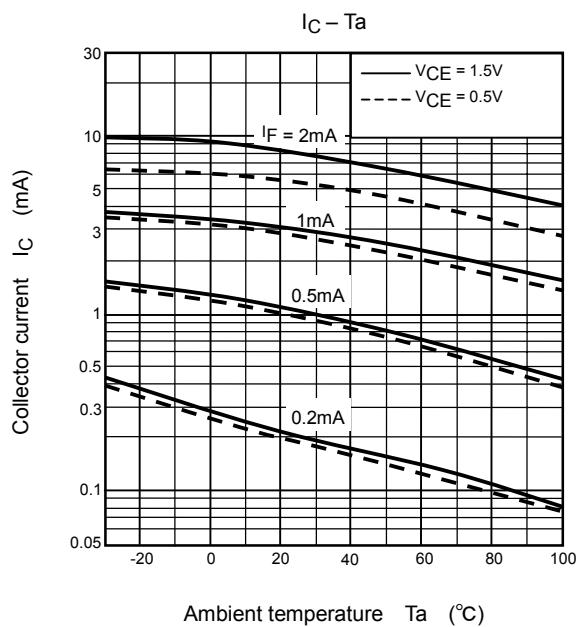
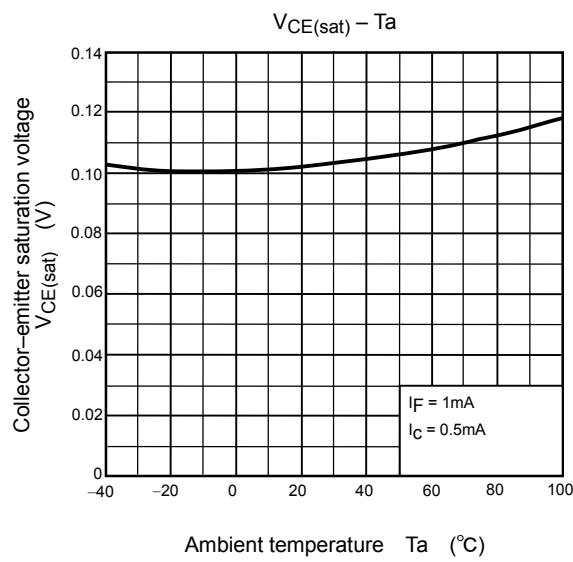
| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|----------------|-----------|--|------|------|------|---------------|
| Rise time | t_r | $V_{CC} = 10 \text{ V}, I_C = 2 \text{ mA}$ $R_L = 100\Omega$ | — | 8 | — | μs |
| Fall time | t_f | | — | 8 | — | |
| Turn-on time | t_{on} | | — | 10 | — | |
| Turn-off time | t_{off} | | — | 8 | — | |
| Turn-on time | t_{ON} | $R_L = 4.7 \text{ k}\Omega$ $V_{CC} = 5 \text{ V}, I_F = \pm 1.6 \text{ mA}$ (Fig.1) | — | 10 | — | μs |
| Storage time | t_s | | — | 50 | — | |
| Turn-off time | t_{OFF} | | — | 300 | — | |

Fig. 1 Switching time test circuit









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